

PATENT



IBM/145DV1
Confirmation No. 3332

2841 84
02-14-02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Mark Kenneth Hoffmeyer et al. Art Unit: 2841
Serial No.: 09/924,711 Examiner: Unknown
Filed: August 8, 2001 Atty. Docket No.: IBM/145DV1
For: PROCESSING OF CIRCUIT BOARDS WITH PROTECTIVE, ADHESIVE-LESS
COVERS ON AREA ARRAY BONDING SITES

TRANSMITTAL

Assistant Commissioner for Patents
Washington, DC 20231

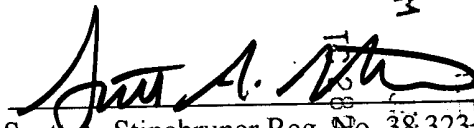
Sir:

We are transmitting herewith the attached:

Transmittal (in duplicate) containing Certificate of Mailing Under 37 CFR 1.8
Supplemental Information Disclosure Statement
Substitute Form PTO-1449 (1 page)
Reply Postcard

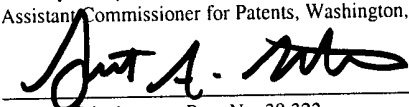
Please charge any additional fees or credit overpayment to Deposit Account No. 23-3000.
A duplicate of this sheet is enclosed.

WOOD, HERRON & EVANS, L.L.P.
2700 Carew Tower
441 Vine Street
Cincinnati, Ohio 45202
(513) 241-2324

By: 
Scott A. Stinebruner Reg. No. 38,323

CERTIFICATE OF MAILING 37 CFR 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to
Assistant Commissioner for Patents, Washington, D.C. 20231 on October 30, 2001.


Scott A. Stinebruner Reg. No. 38,323